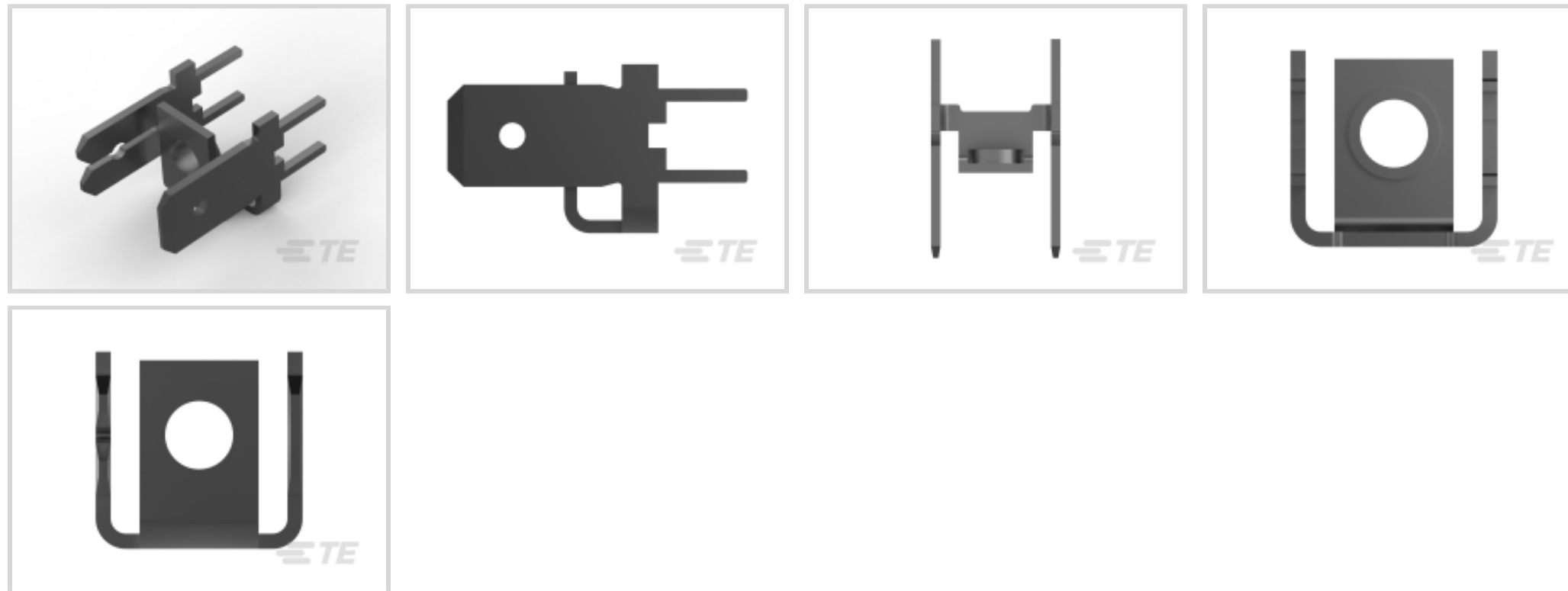




Terminals & Splices > PCB Terminals



PCB Terminal Type: **Receptacle**

PCB Thickness (Recommended): 1.57 mm [.062 in]

Mating Tab Width: 6.35 mm [.25 in]

Mating Tab Thickness: .81 mm [.032 in]

Profile Height from PCB: 13 mm [.518 in]

## Features

### Contact Features

PCB Contact Termination Area Plating Material Thickness	2.54 μm[100 μin]
Contact Underplating Material Thickness	1.25 μm[49.21 μin]
Contact Mating Area Plating Material Thickness	2.54 μm[100 μin]
PCB Terminal Type	Receptacle
Mating Tab Width	6.35 mm[.25 in]
Mating Tab Thickness	.81 mm[.032 in]
Terminal Plating Material	Tin
Terminal Orientation	Straight

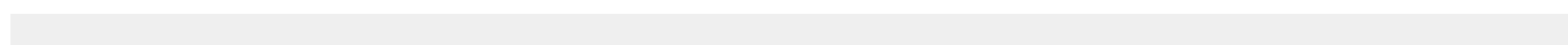
### Termination Features

Termination Method to Printed Circuit Board	Through Hole - Press-Fit
Product Terminates To	Printed Circuit Board

### Mechanical Attachment

Wire Insulation Support	Without
-------------------------	---------

### Dimensions





Extension Below Board	5.5 mm[.216 in]
Terminal Material Thickness	.81 mm[.032 in]
PCB Thickness (Recommended)	1.57 mm[.062 in]
Profile Height from PCB	13 mm[.518 in]

### Usage Conditions

Insulation Option	Uninsulated
-------------------	-------------

### Packaging Features

Packaging Method	Box
------------------	-----

### Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

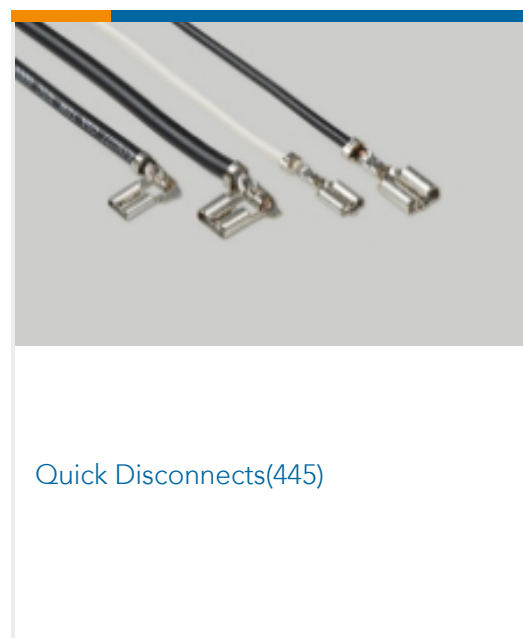
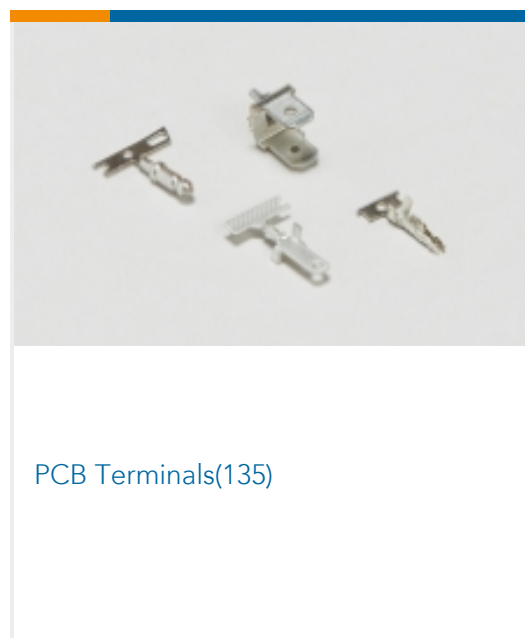
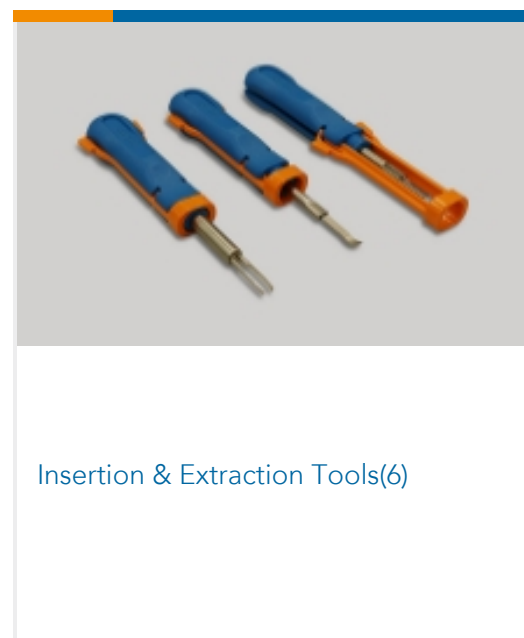
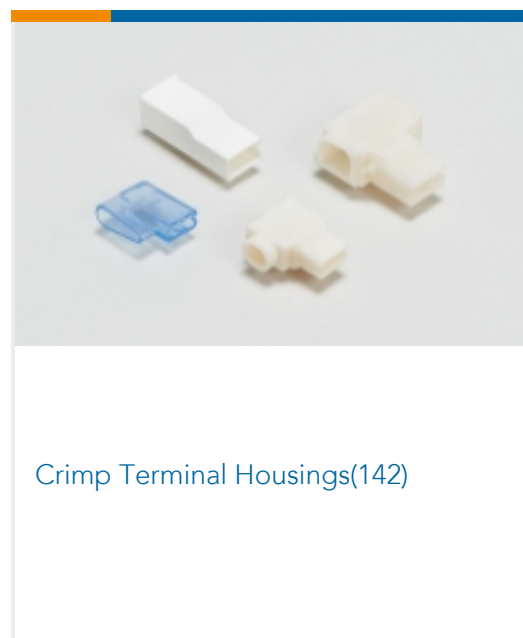
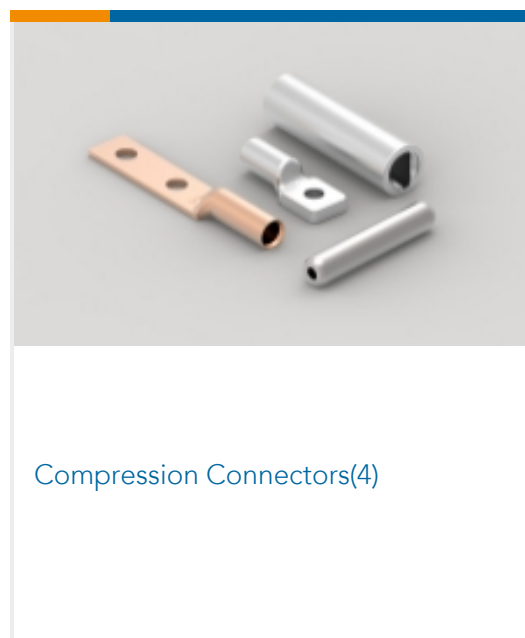
#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

### Compatible Parts

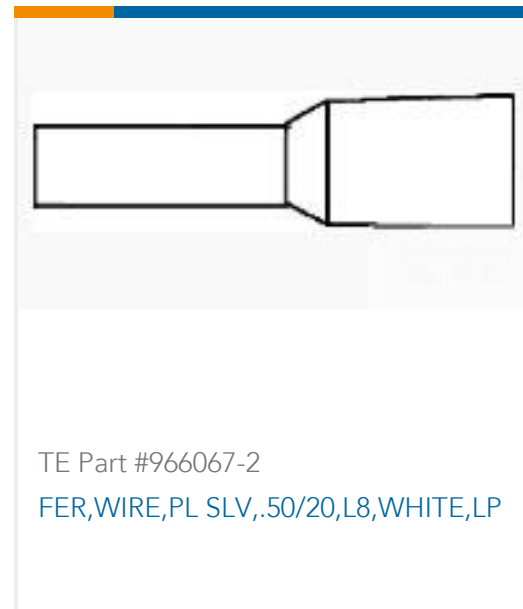
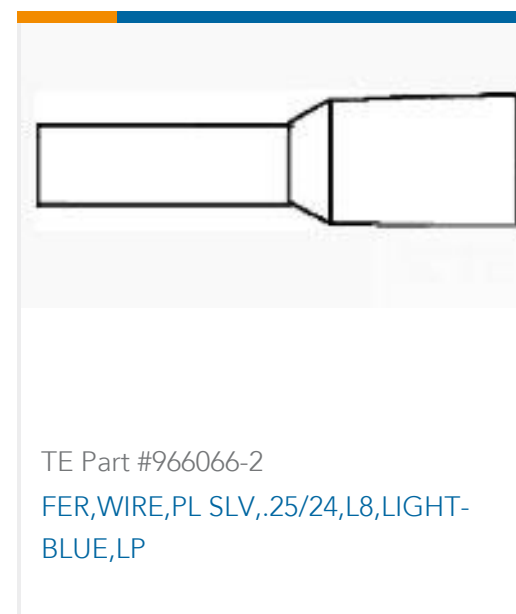


Also in the Series | **FASTON 250**



Customers Also Bought





## Documents

### CAD Files

3D PDF

3D

Customer View Model

[ENG\\_CVM\\_CVM\\_216905-1\\_A.2d\\_dxf.zip](#)

English

Customer View Model

[ENG\\_CVM\\_CVM\\_216905-1\\_A.3d\\_igs.zip](#)

English

Customer View Model

[ENG\\_CVM\\_CVM\\_216905-1\\_A.3d\\_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

### Datasheets & Catalog Pages

[POWER\\_CONNECTORS\\_CATALOG\\_SEC02\\_CABLE\\_MOUNTED](#)

English

[PRINTED CIRCUIT BOARD TERMINALS AND DISCONNECTS](#)

English